

Technical Data Sheet 0805 Package Chip LED(1.0mm Height)

17-21/GHC-XS1T2M/3T

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain with in RoHS compliant version.



- The 17-21 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

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D (N	Chip		Resin Color	
Part No.	Material	Emitted Color		
17-21/GHC-XS1T2M/3T	InGaN	Brilliant Green	Water Clear	



Device No.: DSE-000 Prepared date:30-Jun.-2011 Prepared by:ZhouChen

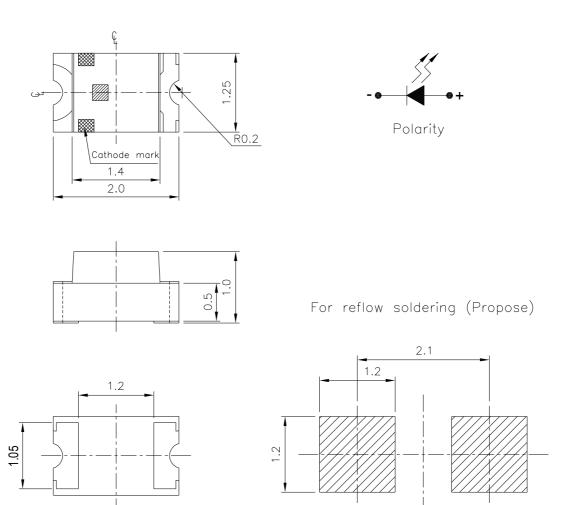
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Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Absolute Maximum Ratings (Ta=25 $^{\circ}$ C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I_{F}	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	$ m I_{FP}$	100	mA	
Power Dissipation	P_d	95	mW	
ElectrostaticDischarge (HBM)	ESD	150	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}$ C	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec Hand Soldering: 350°C for 3 sec		

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	$I_{\rm v}$	180		450	mcd	
Viewing Angle	$2 heta_{ ext{1/2}}$		140		deg	
Peak Wavelength	λp		518		nm	
Dominant Wavelength	λd	515		530	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ		35		nm	
Forward Voltage	V_{F}	2.75		3.95	V	
Reverse Current	I_R			50	μΑ	V _R =5V

Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

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Bin Range Of Dom. Wavelength

		T			
Groups	Bin	Min	Max	Unit	Condition
	W 515 520				
X	X	520	525	nm	$I_F=20mA$
	Y	525	530		

Bin Range Of Luminous Intensity

		/			
Bin	Min	Max	Unit	Condition	
S 1	180	225			
S2	225	285] .	I _F =20mA	
T1	285	360	mcd		
T2	360	450			

Bin Range Of Forward Voltage

Groups	Bin	Min	Max	Unit	Condition	
М	5	2.75	3.05			
	6	3.05	3.35	nm	I _F =20mA	
	7	3.35	3.65			
	8	3.65	3.95			

Notes:

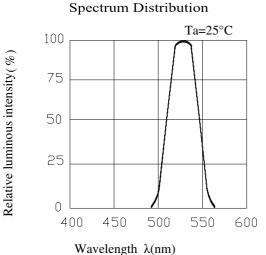
1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

3. Tolerance of Forward Voltage ±0.1V

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Typical Electro-Optical Characteri



50 $I_{F}\left(mA\right)$ 40 30 Forward Current 25 20 10

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Forward Current vs.

Forward Voltage
Ta=25°C

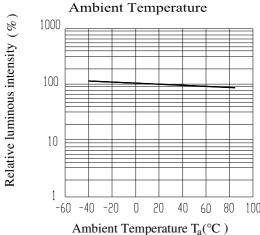
Forward Voltage $V_F(V)$

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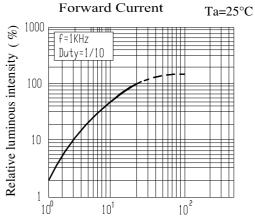
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Luminous Intensity vs.

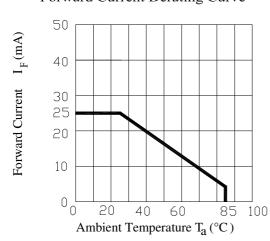


Luminous Intensity vs

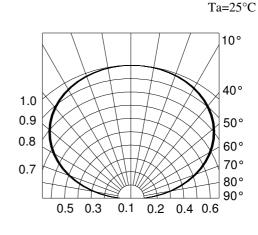


Forward Current I_F (mA)

Forward Current Derating Curve



Radiation Diagram



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Label explanation

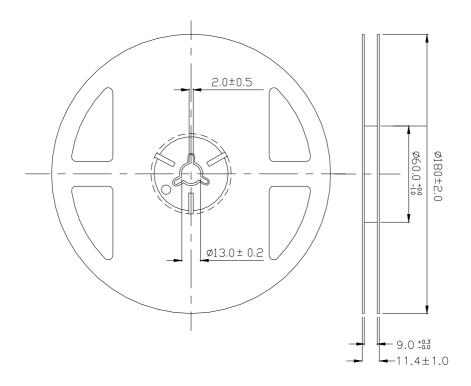
CAT: Luminous Intensity (mcd)

HUE: Dom. Wavelength (nm)

REF: Forward Voltage (V)



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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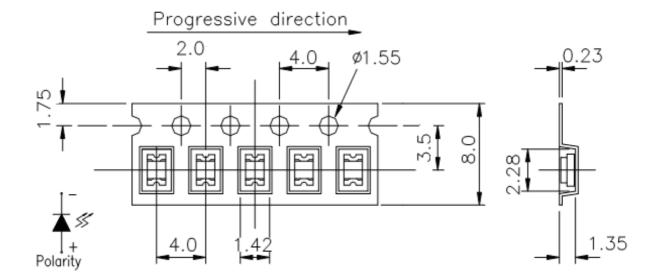
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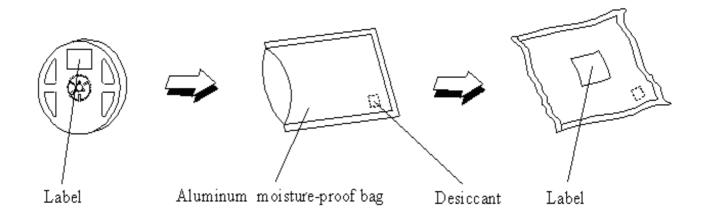
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Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



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Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90 %

LTPD: 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

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Precautions For Use

1. Over-current-proof

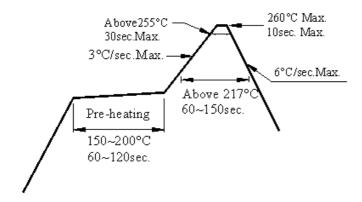
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage time

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment : $60\pm5^{\circ}$ C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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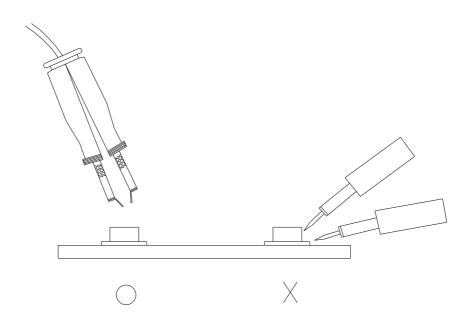


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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